

IN THE DRAWINGS

Per the Examiner's request, proposed amended drawing sheets for Figures 2A-2C and 2D-2F are attached. Applicants submit that the objection to the crosshatch pattern has been overcome, as the pattern has been replaced by shading.

IN THE CLAIMS

Please amend the Claims as per the following Clean Copy:

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1. (Unchanged) An integrated circuit, comprising:

an injection-molded substrate having top channels for addition of circuit material, the top channels having sides extending to a plane defining a top surface of the substrate and a bottom beneath the plane;

a die mounted to the substrate;

a plurality of electrical terminals mounted to the substrate for connecting the die to external circuits; and

circuit material deposited within the channels for forming an electrical connection between the die and the electrical terminals.

2. (Amended) The integrated circuit of Claim 1, wherein the substrate further has bottom channels having sides extending to a bottom plane defining a bottom surface of the substrate and a top beneath the top surface, and wherein the circuit material is further deposited within the bottom channels.

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MAR 20 2003
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